onsemi

Automotive 750 V, 600 A Dual Side Cooling Half-Bridge Power Module

VE-Trac[™] Dual Gen II NVG600A75L4DSC2

Product Description

The NVG600A75L4DSC2 is part of a family of power modules with dual side cooling and compact footprints for Hybrid (HEV) and Electric Vehicle (EV) traction inverter application.

The module consists of two narrow mesa Field Stop (FS4) IGBTs in a half-bridge configuration. The chipset utilizes the new narrow mesa IGBT technology in providing high current density and robust short circuit protection with higher blocking voltage to deliver outstanding performance in EV traction applications.

Liquid cooling heatsink reference design, loss models and CAD models are available to support customers in inverter designs.

Features

- Dual-Side Cooling
- Integrated Chip Level Temperature and Current Sensor
- T_{vi max} = 175°C for Continuous Operation
- Low-Stray Inductance
- Low Conduction and Switching Losses
- Automotive Grade
- 4.2 kV Isolated DBC Substrate
- AEC Qualified and PPAP Capable
- This Device is Pb-Free and is RoHS Compliant

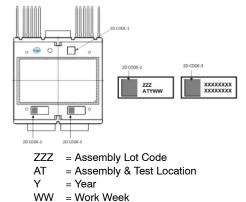
Typical Applications

- Hybrid and Electric Vehicle Traction Inverter
- High Power DC-DC Boost Converter

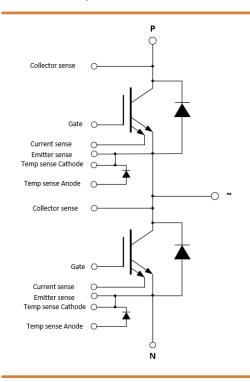


AHPM15-CEA CASE MODHS





XXXX = Specific Device Code



ORDERING INFORMATION

See detailed ordering and shipping information on page 5 of this data sheet.

PIN DESCRIPTION

Pin #	Pin	Pin Function Description	Pin Arrangement
1	N	Low Side Emitter	2
2	Р	High Side Collector	
3	H/S COLLECTOR SENSE	High Side Collector Sense	3 0
4	H/S CURRENT SENSE	High Side Current Sense	
5	H/S EMITTER SENSE	High Side Emitter Sense	
6	H/S GATE	High Side Gate	4 0 4 5 0 4 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1
7	H/S TEMP SENSE (CATHODE)	High Side Temp sense Diode Cathode	
8	H/S TEMP SENSE (ANODE)	High Side Temp sense Diode Anode	9
9	~	Phase Output	
10	L/S CURRENT SENSE	Low Side Current Sense	
11	L/S EMITTER SENSE	Low Side Emitter Sense	
12	L/S GATE	Low Side Gate	
13	L/S TEMP SENSE (CATHODE)	Low Side Temp sense Diode Cathode	
14	L/S TEMP SENSE (ANODE)	Low Side Temp sense Diode Anode	
15	L/S COLLECTOR SENSE	Low Side Collector Sense	1

DBC Substrate

Al₂O₃ isolated substrate, basic isolation, and copper on both sides.

Lead Frame

Copper with Tin electro-plating.

Flammability Information

All materials present in the power module meet UL flammability rating class 94V-0.

MODULE CHARACTERISTICS

Symbol	Parameter				Unit
T _{vj}	Continuous Operating Junction Temperature Range			-40 to 175	°C
T _{STG}	Storage Temperature range			-40 to 125	°C
V _{ISO}	SO Isolation Voltage, DC, t = 1 s			4200	V
Creepage	Creepage Minimum: Terminal to Terminal			5.0	mm
Clearance	Clearance Minimum: (Note 1) Terminal to Terminal			3.2	mm
CTI	CTI Comparative Tracking Index				
		Min	Тур	Max	
L _{sCE}	Stray Inductance		8		nH
R _{CC'+EE'}	Module Lead Resistance, Terminals – Chip		0.15		mΩ
G	Module Weight		75		g
М	M4 Screws for Module Terminals			2.2	Nm

1. Verified by design / not by test.

ABSOLUTE MAXIMUM RATINGS (TVJ = 25°C, unless otherwise specified)

Symbol	Parameter	Rating	Unit
IGBT			
V _{CES}	Collector to Emitter Voltage	750	V
V _{GES}	Gate to Emitter Voltage	±20	V
I _{CN}	Implemented Collector Current	600	А
I _{C nom}	Continuous DC Collector Current, Tvjmax = 175° C, T _F = 65° C, Ref. Heatsink	500	А
I _{CRM}	Pulsed Collector Current @ VGE = 15 V, tp = 1 ms	1200	А

DIODE

V _{RRM}	Repetitive Peak Reverse Voltage	750	V
I _{FN}	Implemented Forward Current	600	А
١ _F	Continuous Forward Current, Tvjmax = 175° C, T _F = 65° C, Ref. Heatsink	400	А
I _{FRM}	Repetitive Peak Forward Current, t _p = 1 ms	1200	А
l ² t value	V_{R} = 0 V, t_{p} = 10 ms, Tv _J = 150°C T _{VJ} = 175°C	14000 12000	A ² s

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Symbol	Parameter	Min	Тур	Мах	Unit
IGBT.R _{th,J-C}	Effective Rth, Junction to Case	-	0.06	0.08	°C/W
IGBT.R _{th,J-F}	Effective Rth, Junction to Fluid, $\lambda_{TIM} = 6$ W/m–K, F = 660 N 10 L/min, 65°C, 50/50 EGW, Ref. Heatsink	-	0.146	-	°C/W
Diode.R _{th,J-C}	Effective Rth, Junction to Case	-	0.10	0.13	°C/W
Diode.R _{th,J-F}	Effective Rth, Junction to Fluid, $\lambda_{TIM} = 6$ W/m–K, F = 660 N 10 L/min, 65°C, 50/50 EGW, Ref. Heatsink	-	0.196	-	°C/W

	Parameters	Conditions	Min	Тур	Max	unit
V _{CESAT}	Collector to Emitter Saturation Voltage	$\label{eq:VGE} \begin{array}{ll} V_{GE} = 15 \; \text{V}, \; \text{I}_{C} = 400 \; \text{A}, & T_{vj} = 25 \\ T_{vj} = 150 \\ T_{vj} = 175 \end{array}$	°C –	1.23 1.28 1.30	1.35 - -	V
		$\label{eq:VGE} \begin{array}{ll} V_{GE} = 15 \; V, \; I_C = 600 \; A, & T_{vj} = 25 \\ T_{vj} = 150 \\ T_{vj} = 175 \end{array}$	°C – 0°	1.39 1.53 1.57	- - -	
I _{CES}	Collector to Emitter Leakage Current	$V_{GE} = 0, V_{CE} = 750 \text{ V} \qquad \begin{array}{c} T_{vj} = 25 \\ T_{vj} = 175 \end{array}$	°C – °C –	_ 8	1 -	mA
I _{GES}	Gate – Emitter Leakage Current	V_{CE} = 0, V_{GE} = ±20 V	-	-	±400	nA
V _{th}	Threshold Voltage	$V_{CE} = V_{GE}$, $I_C = 500 \text{ mA}$	4.5	5.6	6.5	V
Q_{G}	Total Gate Charge	V_{GE} = -8 to 15 V, V_{CE} = 400 V, I_{C} = 400 A	-	1.0	-	μC
R _{Gint}	Internal Gate Resistance		-	2	-	Ω
C _{ies}	Input Capacitance	V_{CE} = 30 V, V_{GE} = 0 V, f = 1 MHz	-	36	-	nF
C _{oes}	Output Capacitance	V_{CE} = 30 V, V_{GE} = 0 V, f = 1 MHz	-	0.7	-	nF
C _{res}	Reverse Transfer Capacitance	V_{CE} = 30 V, V_{GE} = 0 V, f = 1 MHz	-	0.09	-	nF
T _{d.on}	Turn On Delay, Inductive Load	$\begin{array}{ll} I_C = 400 \text{ A}, \ V_{CE} = 400 \text{ V} & T_{vj} = 25 \\ V_{GE} = +15/-8 \text{ V} & T_{vj} = 150 \\ \text{Rg.on} = 3.9 \ \Omega & T_{vj} = 175 \end{array}$	°C –	194 224 228		ns
T _r	Rise Time, Inductive Load	$\begin{array}{ll} I_C = 400 \text{ A}, \ V_{CE} = 400 \text{ V} & \ T_{vj} = 25 \\ V_{GE} = +15/-8 \text{ V} & \ T_{vj} = 150 \\ \text{Rg.on} = 3.9 \ \Omega & \ T_{vj} = 175 \end{array}$	°C –	71 89 94	- - -	ns
T _{d.off}	Turn Off Delay, Inductive Load	$\begin{array}{ll} I_C = 400 \; \text{A}, V_{CE} = 400 \; \text{V} & T_{vj} = 25 \\ V_{GE} = +15/-8 \; \text{V} & T_{vj} = 150 \\ \text{Rg.off} = 15 \; \Omega & T_{vj} = 175 \end{array}$	°C –	969 1047 1063		ns
Т _f	Fall Time, Inductive Load	$\begin{array}{ll} I_{C} = 400 \; \text{A}, V_{CE} = 400 \; \text{V} & T_{vj} = 25 \\ V_{GE} = +15/-8 \; \text{V} & T_{vj} = 150 \\ \text{Rg.off} = 15 \; \Omega & T_{vj} = 175 \end{array}$	°C –	123 202 230		ns
E _{ON}	Turn–On Switching Loss (Including Diode Reverse Recovery Loss)	$\begin{array}{l} I_C = 400 \; \text{A}, \; V_{CE} = 400 \; \text{V} \qquad T_{vj} = 25 \\ V_{GE} = +15/{-8} \; \text{V} \qquad T_{vj} = 150 \\ \text{Rg.on} = 3.9 \; \Omega \qquad T_{vj} = 175 \\ \text{Ls} = 25 \; \text{nH} \\ \text{di/dt} \; (T_{vj} = 25^\circ\text{C}) = 4.67 \; \text{A/ns} \\ \text{di/dt} \; (T_{vj} = 175^\circ\text{C}) = 3.61 \; \text{A/ns} \end{array}$	°C – 0°	10.09 16.73 18.57	- -	mJ
E _{OFF}	Turn–Off SwitchingLoss	$\begin{array}{l} I_C = 400 \; \text{A}, \; V_{CE} = 400 \; \text{V} \qquad T_{vj} = 25 \\ V_{GE} = +15/{-8} \; \text{V} \qquad T_{vj} = 150 \\ \text{Rg.off} = 15 \; \Omega \qquad T_{vj} = 175 \\ \text{Ls} = 25 \; \text{nH} \\ \text{dv/dt} \; (T_{vj} = 25^\circ\text{C}) = 2.82 \; \text{V/ns} \\ \text{dv/dt} \; (T_{vj} = 175^\circ\text{C}) = 2.08 \; \text{V/ns} \end{array}$	°C –	15.95 25.06 27.30		mJ
Esc	Minimum Short Circuit Energy Withstand	$V_{GE} \leq 15 \text{ V}, V_{CE} = 400 \text{ V} \qquad \begin{array}{c} T_{vj} = 25 \\ T_{vj} = 175 \end{array}$	°C – °C 3.5	3.5 _	-	J

CHARACTERISTICS OF IGBT (Tvj = 25°C, unless otherwise specified)

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

CHARACTERISTICS OF INVERSE DIODE (Tvj = 25°C, unless otherwise specified)

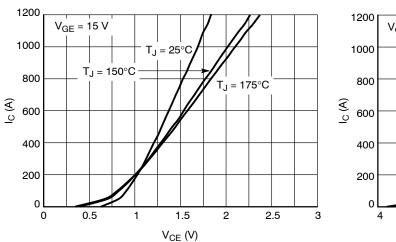
	Parameters	Conditions		Min	Тур	Max	unit
V _F	Diode Forward Voltage	$V_{GE} = 0 V, I_C = 400 A,$	T _{vj} = 25°C T _{vj} = 150°C T _{vj} = 175°C	- - -	1.34 1.30 1.29	1.47 _ _	V
		V _{GE} = 0 V, I _C = 600 A,	$\begin{array}{l} T_{vj} = 25^\circ C \\ T_{vj} = 150^\circ C \\ T_{vj} = 175^\circ C \end{array}$		1.48 1.47 1.46		
Err	Reverse Recovery Energy	$ \begin{array}{l} V_{\text{R}} = 400 \; \text{V}, \; \text{I}_{\text{F}} = 400 \; \text{A}, \\ R_{\text{GON}} = 3.9 \; \Omega, \\ -\text{di/dt} = 3.61 \; \text{A/ns} \; (175^{\circ}\text{C}) \\ V_{\text{GE}} = -8 \; \text{V} \end{array} $	T _{vj} = 25°C T _{vj} = 150°C T _{vj} = 175°C		1.05 4.93 5.90		mJ
Q _{RR}	Recovered Charge	$ \begin{array}{l} {\sf V}_{\sf R} = 400 \; {\sf V}, \; {\sf I}_{\sf F} = 400 \; {\sf A}, \\ {\sf R}_{\sf GON} = 3.9 \; \Omega, \\ -di/dt = 3.61 \; {\sf A}/ns \; (175^{\circ}{\rm C}) \\ {\sf V}_{\sf GE} = -8 \; {\sf V} \end{array} $	T _{vj} = 25°C T _{vj} = 150°C T _{vj} = 150°C		11.60 25.72 29.28		μC
Irr	Peak Reverse Recovery Current	$ \begin{array}{l} {\sf V}_{\sf R} = 400 \; {\sf V}, \; {\sf I}_{\sf F} = 400 \; {\sf A}, \\ {\sf R}_{\sf GON} = 3.9 \; \Omega, \\ -di/dt = 3.61 \; {\sf A}/ns \; (175^\circ C) \\ {\sf V}_{\sf GE} = -8 \; {\sf V} \end{array} $	$T_{vj} = 25^{\circ}C$ $T_{vj} = 150^{\circ}C$ $T_{vj} = 175^{\circ}C$		241 294 304		A

SENSOR CHARACTERISTICS (Tvj = 25°C, unless otherwise specified)

	Parameters	Conditio	ons	Min	Тур	Max	unit
T _{sense}	Temperature Sense	I _F = 1 mA,	T _{vj} =25°C T _{vj} = 150°C T _{vj} = 175°C		2.5 1.7 1.5		V
I _{sense}	Current Sense	R _{shunt} = 10 Ω,	I _C = 1200 A I _C = 600 A I _C = 100 A		416 223 50		mV

ORDERING INFORMATION

Part Number	Package	Shipping
NVG600A75L4DSC2	AHPM15-CEA Module Case MODHS (Pb-Free)	18 Units / 3x Tub



TYPICAL CHARACTERISTICS

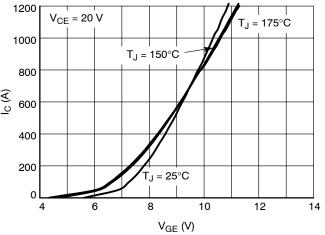


Figure 2. IGBT Transfer Characteristic

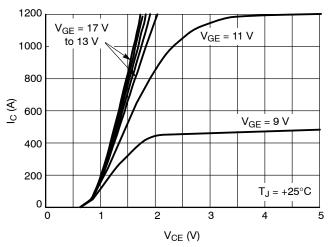
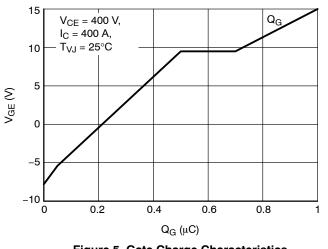
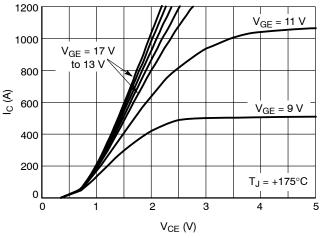


Figure 1. IGBT Output Characteristic











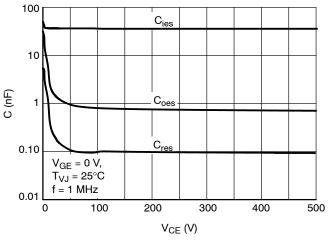
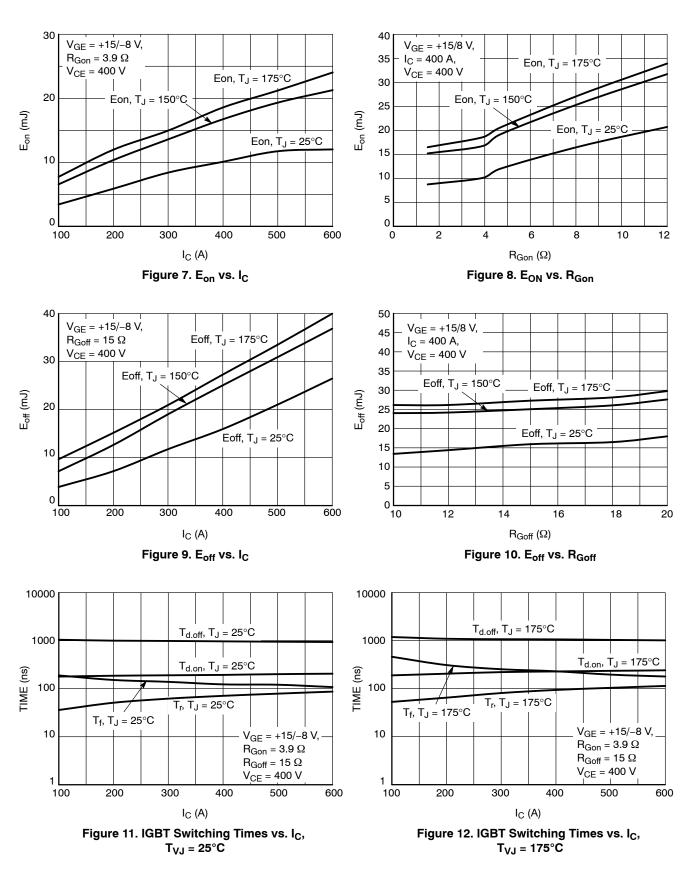
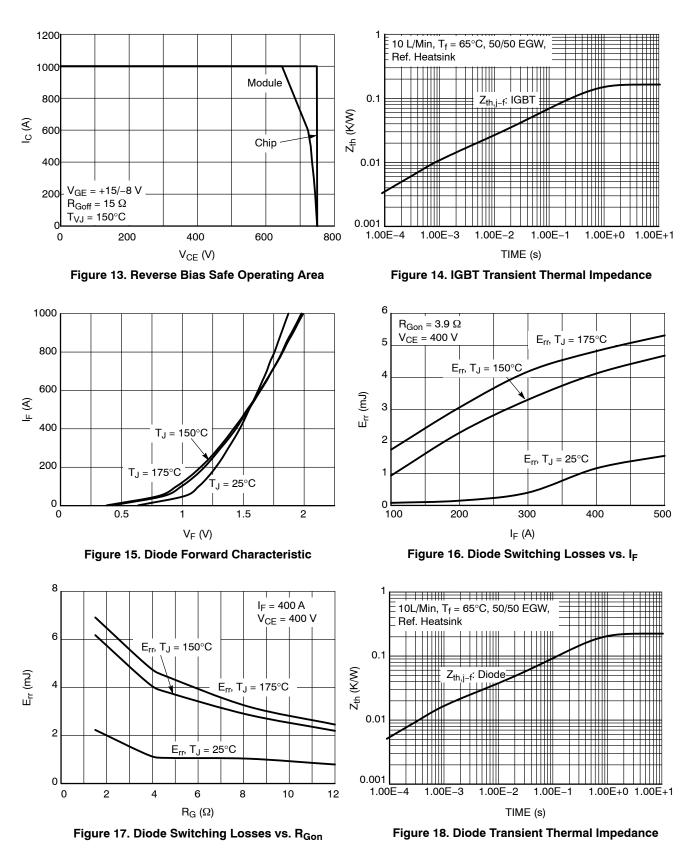


Figure 6. Capacitance Characteristics



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

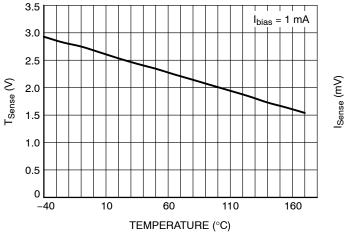


Figure 19. Temperature Sensor Characteristic

TYPICAL CHARACTERISTICS

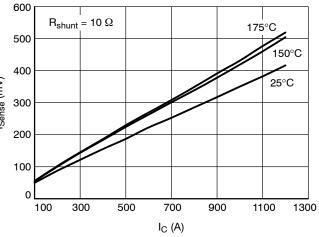
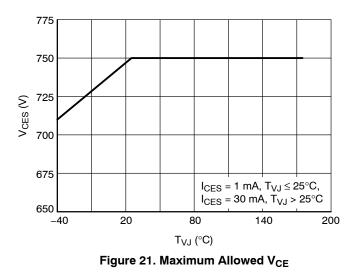


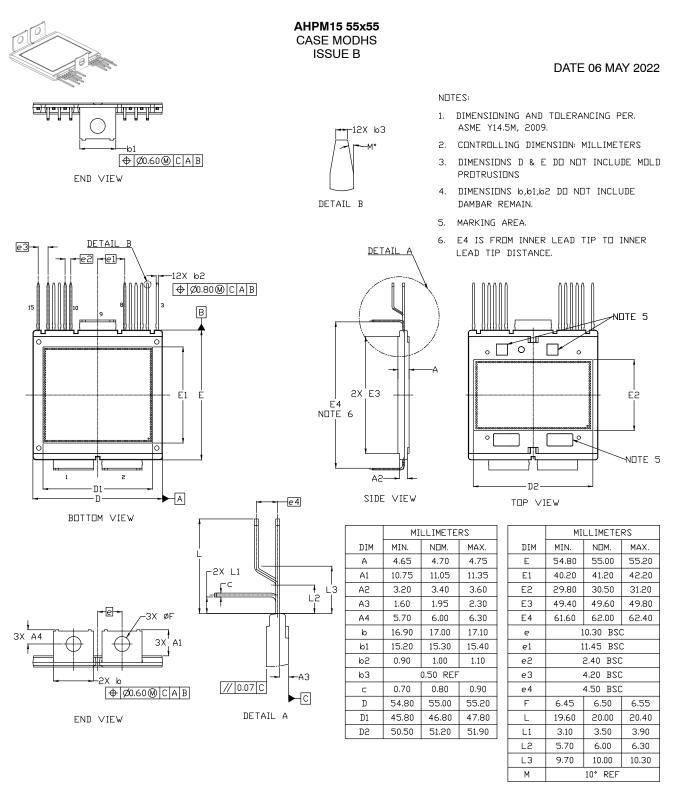
Figure 20. Current Sensor Characteristic



General Note: These are preliminary values measured from a small number of DV units. Values will be updated based on higher quantity of PV measurements.

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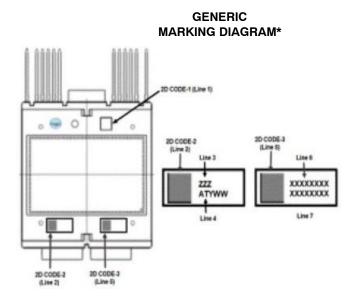


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AHPM15 55x55 CASE MODHS ISSUE B

DATE 06 MAY 2022



- ZZZ = Assembly Lot Code
- AT = Assembly & Test Location
 - = Year

Υ

- WW = Work Week
- XXXX = Specific Device Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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